

#### **Features**

- Supporting 200Gbps to 2x100Gbps
- Wire AWG:30AWG,28AWG
- Available length range 3m~5m
- Operating data rates 200Gbps
- Power supply: +3.3V
- Max power dissipation <1.5W</li>
- Commercial temperature range 0°C to 70°C
- I2C based two-wire serial interface for EEPROM signature which can be customized

## **Compliance**

- Compliant with QSFP56 MSA
- Compliant with Electrical MSA SFF-8636
- Compliant with Mechanical MSA SFF-8665
- IEEE 802.3bj
- RoHS

## **Applications**

- 200/100 Gigabit Ethernet
- Switches, servers, routers and HBA
- Data center cabling infrastructure
- High speed multi-channel parallel data connections



## **Description**

The 200G-Q56-2Q-AC is a high-performance, cost-effective solution designed to enable seamless connectivity in 200Gb/s applications. This 200G QSFP56 to 2x100G QSFP56 Active Direct Attach Copper Cable offers a reliable alternative to fiber optics, ensuring efficient data transmission at high speeds. Fully compliant with SFF-8665 QSFP56 MSA standards, the cable provides a convenient breakout configuration, featuring a 200G QSFP56 connector on one end and two 100G QSFP56 connectors on the other.

Ideal for short-range interconnections, the 200G-Q56-2Q-AC is perfect for telecom operators, data centers, and equipment rooms where high-speed, reliable connections are required. This active copper cable ensures low latency and high data integrity, making it an optimal choice for demanding data transmission environments.

## **Product performance Specifications**

#### 1. Basic Product Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit
Storage Temperature	Ts	-40		85	°C
Operating Case Temperature	Tc	0		70	°C
Relative Humidity	RH	5		85	%
Power Supply Voltage	Vcc	3.135	3.3	3.465	V
Data Rate	DR			212.5	Gbp/s

### 2. High Speed Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit	Conditions
Differential Impedance	TDP	90	100	110	Ω	
Insertion loss	SDD21	-17.16			dB	13.28 GHz
Common-mode to common-mode output return loss	SCC11 SCC22			-2	dB	0.2 to 19GHz
Differential Return Loss	SDD11	12.45		See1	dB	0.05 to 4.1GHz
Differential Neturn 2055	SDD22	3.12		See2	uБ	4.1GHz to 19GHz
Differential to common-mode	SCD11			See3	dB	0.01 to 12.89 GHz
return loss	SCD22			See4	ив	12.89 to 19 GHz
Differential to common Made				-10		0.01 to 12.89 GHz
Differential to common Mode  Conversion Loss	SCD21-IL			See5	dB	12.89 to 15.7 GHz
CONVENSION LOSS				-6.3		15.7 to 19 GHz



Note1: Reflection Coefficient given by equation SDD11(dB) <-16.5 + 2 × SQRT(f), with fin GHz.

Note2: Reflection Coefficient given by equation SDD11(dB) < -10.66 + 14 × log10(f/5.5), with fin GHz.

Note3: Reflection Coefficient given by equation SCD11(dB) < -22 + (20/25.78)\*f, with fin GHz.

Note4: Reflection Coefficient given by equation SCD11(dB) < -15 + (6/25.78)\*f, with fin GHz

Note5: Reflection Coefficient given by equation SCD21(dB) <-27 + (29/22)\*f, with fin GHz.

#### 3. Product Optical and Electrical Characteristics

Test Type	Test Item	24AWG	26AWG	28AWG	30AWG
	Differential impedance	100±5Ω at TDR	100±5Ω	100±5Ω	100±5Ω at TDR
	Mutual capacitance	14pF/ft nominal	14pF/ft nominal	14pF/ft nominal	14pF/ft nominal
	Time delay	1.31ns/ft nominal, (4.3ns/m) nominal	1.35ns/ft nominal	1.35ns/ft nominal	1.35ns/ft nominal, (4.3ns/m) nominal
Electrical	Time delay skew (within pairs)	80ps/10m maximum	120ps/8.5m maximum	120ps/7m maximum	50ps/5.5m maximum
Electrical Characteristics	Time delay skew (between pairs)	350ps/10m maximum	500ps/8.5m maximum	500ps/7m maximum	350ps/5.5m maximum
	Attenuation	10dB/10m maximum at 1.25Ghz	10dB/8.5m maximum at 1.25Ghz	10dB/7m maximum at 1.25Ghz	8.4dB/5.5m maximum at 1.25Ghz
	Conductor DC Resistance	$0.026\Omega$ /ft maximum at 20°C	0.04Ω /ft maximum at 20°C	0.06Ω/ft maximum at 20°C	0.01Ω/ft maximum at 20°C
	Conductors (two pair)	24AWG Solid, Silver plated copper	26AWG Solid, Silver plated copper	28AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper
	Insulation	Foam polyolefin	Foam polyolefin	Foam polyolefin	Foam polyolefin
	Pair drain wire	26AWG Solid, Silver plated copper	28AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper
Physical Characteristics	Overall cable shield	Aluminum/polyester tape, 125% coverage, Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyester tape, 125% coverage, Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyest er tape, 125% coverage,Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyester tape, 125% coverage,Tin plated copper braid, 38AWG, 85% coverage
	Outer diameter	6.0mm	5.2mm	4.7mm	4.2mm



# **Recommended Host Board Power Supply Circuit**

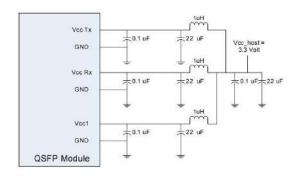


Figure 1:Recommended Host Board Power Supply Circuit

## **Recommended Interface Circuit**

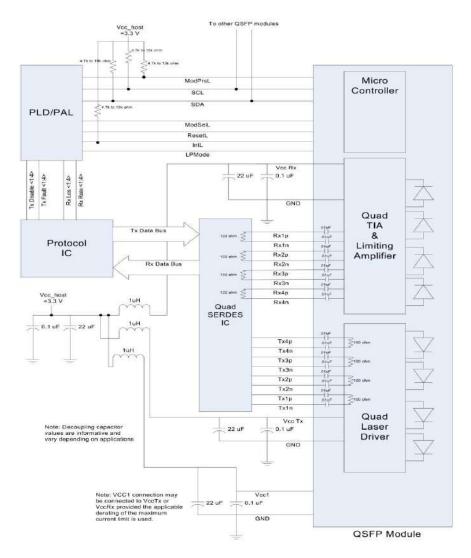


Figure2:Recommended Interface Circuit



# **Pin-out Definition**

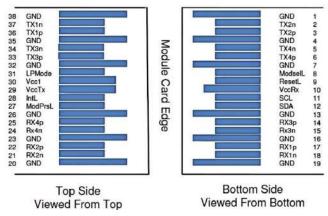


Figure3:Pin view

## **Pin Function Definitions**

Pin	Logic	Symbol	Description	Note
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	4
9	LVTTL-I	ReSelL	Module Select	4
10		Vcc Rx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-wire serial interface clock	4
12	LVCMOS-I/O	SDA	2-wire serial interface data	4
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3
15	CML-O	Rx3n	Receiver Inverted Data Output	3
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3
18	CML-O	Rx1n	Receiver Inverted Data Output	3
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3



25	CML-O	Rx4p	Receiver Non-Inverted Data Output Ground	3
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	4
28	LVTTL-O	IntL	Interrupt	4
29		Vcc Tx	+3.3V Power supply transmitter	2
30		Vcc1	+3.3V Power supply	2
31	LVTTL-I	LPMode	Low Power Mode	4
32		GND	Ground	1
33	CML-I	Тх3р	Transmitter Non-Inverted Data Input	3
34	CML-I	Tx3n	Transmitter Inverted Data Input	3
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3
37	CML-I	Tx1n	Transmitter Inverted Data Input	3
38		GND	Ground	1

**Note1:** GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP+ module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note2: Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in Table. Recommended host board power supply filtering is shown in Host board power supply circuit. Vcc Rx Vcc1 and Vcc Tx may be internally connected within the QSFP module in any combination. The connector pins are each rated for a maximum current of 500 mA.

Note3: High-speed signal interfaces require differential pairs (e.g. TX1+/TX1-) with tightly matched impedances (typically 100Ω).

Note4: The management and control signals are based on LVTTL level logic and are used for functions such as module selection and reset.



# **Monitoring Specification**

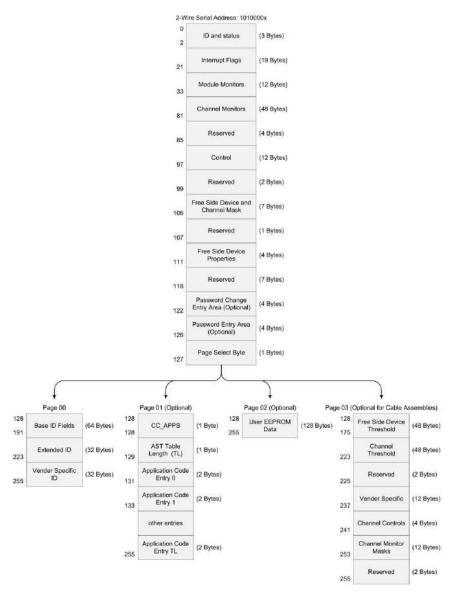


Figure4:Memory map

# **Memory map Table**

Byte	Unit	Name	Description		
			Lower Page 00h		
0	1	Identifier	Type of transceiver,Page 00h Byte 0 and Page 00h Byte 128 shall contain the same parameter values.		
1	1	Status	Revision Compliance		
2	1	Status	Status indicators		
3-21	19	Interrupt Flags	Consist of interrupt flags for LOS, Tx Fault, warnings and alarms. The non-asserted state shall be 0b.		



22	1	Temperature MSB	Internally measured temperature (MSB)			
23	1	Temperature LSB	Internally measured temperature (LSB)			
24-25	2	Reserved	Reserved			
26	1	Supply Voltage MSB	Internally measured supply voltage (MSB)			
27	1	Supply Voltage LSB	Internally measured supply voltage (LSB)			
28-29	2	Reserved	Reserved			
30-33	4	Vendor Specific	Vendor Specific			
34	1	Rx1 Power MSB	vendor opeanie			
35	1	Rx1 Power LSB	Internally measured Rx1 input power			
36	1	Rx2 Power MSB				
37	1	Rx2 Power LSB	Internally measured Rx2 input power			
38	1	Rx3 Power MSB				
39	1	Rx3 Power LSB	Internally measured Rx3 input power			
40	1	Rx4 Power MSB				
41	1	Rx4 Power LSB	Internally measured Rx4 input power			
42	1	Tx1 Bias MSB				
43	1	Tx1 Bias LSB	Internally measured Tx1 bias			
44	1	Tx2 Bias MSB				
45	1	Tx2 Bias LSB	Internally measured Tx2 bias			
46	1	Tx3 Bias MSB				
47	1	Tx3 Bias LSB	Internally measured Tx3 bias			
48	1	Tx4 Bias MSB				
49	1	Tx4 Bias LSB	Internally measured Tx4 bias			
50	1	Tx1 Power MSB				
51	1	Tx1 Power LSB	Internally measured Tx1 Power			
52	1	Tx2 Power MSB				
53	1	Tx2 Power LSB	Internally measured Tx2 Power			
54	1	Tx3 Power MSB				
55	1	Tx3 Power LSB	Internally measured Tx3 Power			
56	1	Tx4 Power MSB				
57	1	Tx4 Power LSB	Internally measured Tx4 Power			
58-65	8	Reserved	Reserved channel monitor set 4			
66-73	8	Reserved	Reserved channel monitor set 5			
74-81	8	Vendor Specific	Vendor Specific			
82-85	4	Reserved	Reserved			
86-99	14	Control	Control			
100-106	7	Free Side Device and Channel Masks	Free Side Device and Channel Masks			
107-110	4	Free Side Device Properties	Free Side Device Properties			
111-112	2	Assigned for use by	Used for:			



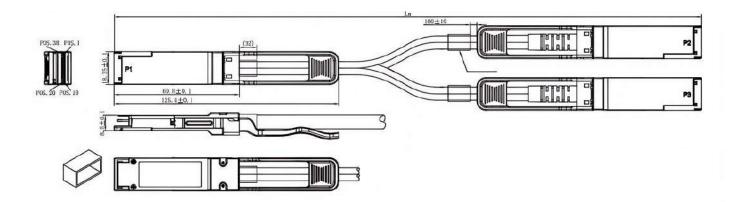
		PCI Express	- The PCI Express External Cable Specification
			- The PCI Express OCuLink Specification
113-117	4	Free Side Device Properties	Free Side Device Properties
118	1	Reserved	Reserved
119-122	4	Password Change Entry Area	Password Change Entry Area
123-126	4	Password Entry Area	Password Entry Area
127	1	Page Select Byte	Page Select Byte
			Upper Page 00h
128	1	Identifier	Identifier Type of free side device.(See SFF-8024 Transceiver Management)
129	1	Ext. Identifier	Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability.
130	1	Connector Type	Code for media connector type. (See SFF-8024 Transceiver Management)
131-138	8	Specification Compliance	Code for electronic or optical compatibility.
139	1	Encoding	Code for serial encoding algorithm. (See SFF-8024 Transceiver Management)
140	1	Signaling rate, nominal	Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222.
141	1	Extended Rate Select Compliance	Tags for extended rate select compliance.
142	1	Length (SMF)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for SMF fiber in km *. A value of 1 shall be used for reaches from 0 to 1 km.
143	1	Length (OM3 50 um)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for EBW 50/125 um fiber (OM3), units of 2 m *
144	1	Length (OM2 50 um)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for 50/125 um fiber (OM2), units of 1 m *
145	1	Length (OM1 62.5 um) or Copper Cable Attenuation	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for $62.5/125$ um fiber (OM1), units of 1 m *, or copper cable attenuation in dB at $25.78$ GHz.
146	1	Length (passive copper or active cable or OM4 50 um)	Length of passive or active cable assembly (units of 1 m) or link length supported at the signaling rate in byte 140 or page 00h byte 222, for OM4 50/125 um fiber (units of 2 m) as indicated by Byte 147. See 6.3.12.
147	1	Device technology	Device technology
148-163	16	Vendor name	Free side device vendor name (ASCII)
164	1	Extended Module	Extended Module codes for InfiniBand.
165-167	3	Vendor OUI	Free side device vendor IEEE company ID.
168-183	16	Vendor PN	Part number provided by free side device vendor(ASCII)
184-185	2	Vendor rev	Revision level for part number provided by the vendor(ASCII)
186-187	2	Wavelength or	Nominal laser wavelength (wavelength=value/20 in nm) or copper cable



		Copper Cable	attenuation in dB at 2.5 GHz (Byte 186) and 5.0 GHz (Byte 187)
		Attenuation	
		Wavelength	The range of laser wavelength (+/- value) from nominal wavelength.
188-189	2	tolerance or Copper	(wavelength Tol. =value/200 in nm) or copper cable attenuation in dB at 7.0
		Cable Attenuation	GHz (Byte 188) and 12.9 GHz (Byte 189)
190	1	Max case temp	Maximum case temperature
191	1	CC_BASE	Check code for base ID fields (Bytes 128-190)
192	1	Link codes	Extended Specification Compliance Codes (See SFF-8024)
193-195	3	Options	Optional features implemented.
196-211	16	Vendor SN	Serial number provided by vendor.(ASCII)
212-219	8	Date Code	Vendor's manufacturing date code.
220	1	Diagnostic	Indicates which type of diagnostic monitoring is implemented (if any) in the
220	ı	Monitoring Type	free side device. Bit 1,0 Reserved.
221	1	Enhanced Options	Indicates which optional enhanced features are implemented in the free side
221	'	Enhanced Options	device.
222	1	CC_EXT	Check code for the Extended ID Fields (Bytes 192-222)
224-255	32	Vendor Specific	Vendor Specific EEPROM



#### **Mechanical Dimension**



#### Note:

- Unit: mm
- Tolerance: φ0.1mm if not shown
- · Latch color: black
- When L≤5m, the tolerance is ±5cm, when L>5m, the tolerance is ±1%

#### Waring:

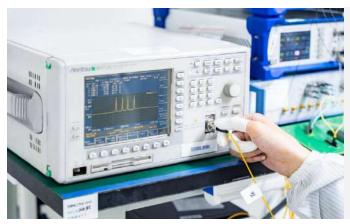
- The transceiver optics is supplied with a dust cover. This plug protects the transceiver optics during standard manufacturing processes by preventing contamination from air borne particles. It is recommended that the dust cover remain in the transceiver whenever an optical fiber connector is not inserted.
- Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.



#### **Test Center**

#### 1. Performance Testing

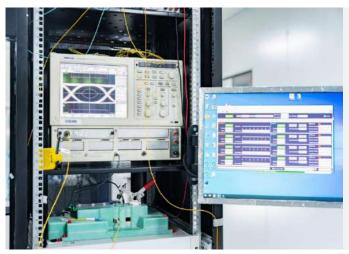
Every fiber optic transceiver is thoroughly tested by the LSOLINK Assurance Program, which is equipped with the world's most advanced analytical equipment to ensure that our transceivers meet the industry's international public protocol standards while still functioning flawlessly in your facility.



#### **Optical Spectrum Inspection**

Using the industry's leading optical spectrum analyser to check in real time that the parameters of the optical transceiver's laser comply with industry standards.

- Peak: Peak wavelength and peak level
- > 2nd Peak: Side-mode wavelength and level
- > Mean WI: Center wavelength
- Total Power: Total power of spectrum
- SMSR: Side-Mode Suppression Ratio



#### **Optical Signal Quality Inspection**

Using highly efficient sampling oscilloscopes and BERT testers, equipped with an automated test platform to accurately test the signal quality of the transceiver, test records are kept for up to 5 years to ensure the traceability of each transceiver.

- Eye Mask Margin(NRZ)
- > TDECQ(PAM4):transmitter dispersion eye closure
- > OMA: Optical modulation amplitude
- **BER:** Bit error rate
- ER: Extinction Ratio



#### **Flow Pressure Test**

Using multi-protocol network traffic analyser with various brands of switches to test the transceiver's ability to transmit at full speed.

- **Bandwidth:** Actual transceiver bandwidth on the port
- Packet Loss
- Packet Errors:CRC Errors/PCS Errors/Symbol Errors
- LinkDown Counts
- > latency

Aboveis part of our test bed network equipment. For more information, Please click <u>download</u> for optical transceiver performance test report.



## 2. Quality Control

We adopt advanced quality management solutions. Each transceiver is self-inspected, including:20x microscope inspection, 200x microscope inspection, and QC process inspection.



visual inspection



Microscopic inspection: 20X



Microscopic inspection: 200X



**Reliability Verification** 



**Optical endface inspection** 



**OQC** Inspection



# **Order Information**

Part Number	Length(m)	Wire Gauge(AWG)	Connector Type	Cable Type	Cable Jacket
200G-Q56-2Q-AC3	3	30	QSFP56 to 2xQSFP56	Active Copper	PVC
200G-Q56-2Q-AC4	4	30	QSFP56 to 2xQSFP56	Active Copper	PVC
200G-Q56-2Q-AC5	5	28	QSFP56 to 2xQSFP56	Active Copper	PVC



# **Further Information**

Lighting the Path to Global Links

Web | www.lsolink.com

☑ Email | For Sales@lsolink.com

# Disclaimer

- We are committed to continuous product improvement and feature upgrades, and the contents cont ained in this manual are subject to change without notice.
- 2. Nothing herein should be construed as constituting an additional warranty.
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